

Features

- Support bus power and power extraction
- Solid-state circuit, noise-free
- Equivalent inductance: 2.5mH
- Operating voltage: 12V to 60V
- Output current: 200mA
- Communication speed adaptation from 9.6kbps to 200kbps
- Operating temperature: -40°C~125°C
- Available in DFN4*4-10 package

Applications

- Central Air Conditioner
- HVAC
- Smart Home
- Communication Device

General Description

The XL1101 is an active inductor specifically optimized for DC power line communication solutions. Built with solid-state circuitry, it features a compact footprint, silent operation, long lifespan, high reliability, a wide operating voltage range, and a high saturation current, making it an ideal replacement for traditional differential-mode transformers. The XL1101 supports both bus powering and power harvesting. On the master side, it enables the power supply to deliver power onto the bus; on the slave side, it extracts power from the bus to supply downstream loads.

Manufactured using solid-state technology, the XL1101 supports communication data rates from 9.6 kbps to 200 kbps. With no magnetic cores or coils inside, it eliminates mechanical oscillation noise. Additionally, its small size and lightweight design effectively minimize PCB footprint.

Typical application schematic

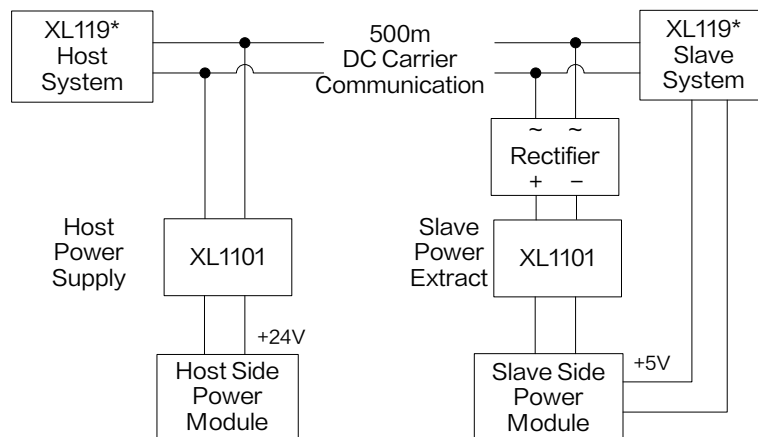


Figure1. Typical Application of XL1101

60V 200mA Active Inductor

XL1101

Pin Configurations

VO+	1		10	VO-
VO+	2		9	VO-
VO+	3	XL1101	8	IN-
IN+	4		7	IN-
IN+	5		6	IN-



Figure2. Pin Configuration of XL1101

Table 1 Pin Description

Pin Number	Pin Name	Description
1~3	VO+	Positive output, connect to load positive.
4~5	IN+	Positive input, connect to power supply positive.
6~8	IN-	Negative input, connect to power supply negative.
9~10	VO-	Negative output, connect to load negative.

Ordering Information

Order Information	Marking ID	Package Type	Eco plan	Packing Type Supplied As
XL1101	XL1101	DFN4*4-10	RoHS & HF	1000 Units on Reel

60V 200mA Active Inductor

XL1101

Function Block

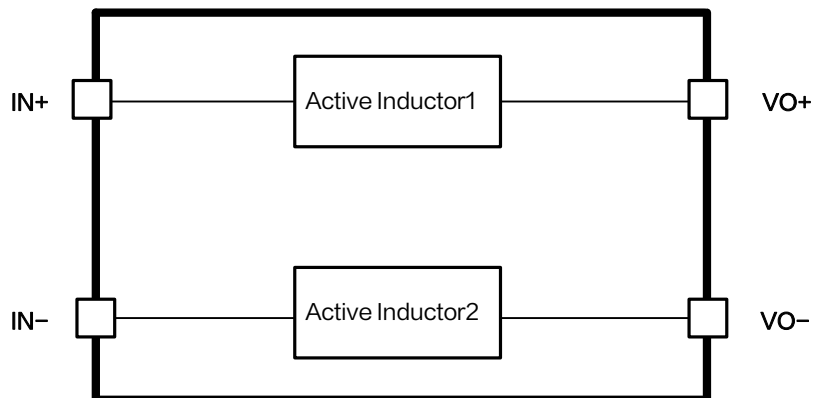


Figure3. Function Block Diagram of XL1101

Absolute Maximum Ratings (Note1)

Parameter	Symbol	Value	Unit
Operating Junction Temperature	T_J	-40 ~ 125	°C
Storage Temperature	T_{STG}	-65 ~ 150	°C
Lead Temperature (Soldering, 10 sec)	T_{LEAD}	260	°C

Note1: Stresses greater than those listed under Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

60V 200mA Active Inductor

XL1101

Electrical Characteristics

T_A = 25°C, Communication speed 19.2kbps.

Parameters	Symbol	Min.	Typ.	Max.	Unit
Operating Voltage	V _{IN}	12	–	60	V
Rated Current	I _{OUT}	–	200	–	mA
Rated Power Consumption	P _D	–	800	–	mW
Equivalent Inductance 1	L1	–	2.5	–	mH
Equivalent Inductance 2	L2	–	2.5	–	mH

Typical Application Schematic–Host Power Supply

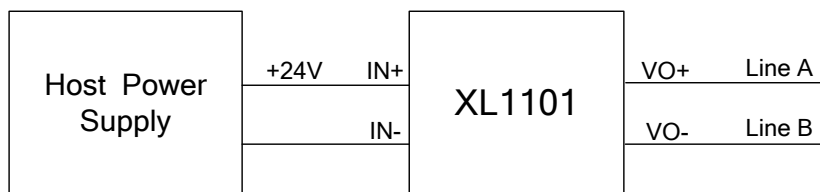


Figure4.XL1101 Application Schematic–Host Power Supply

Typical Application Schematic–Slave Power Extract

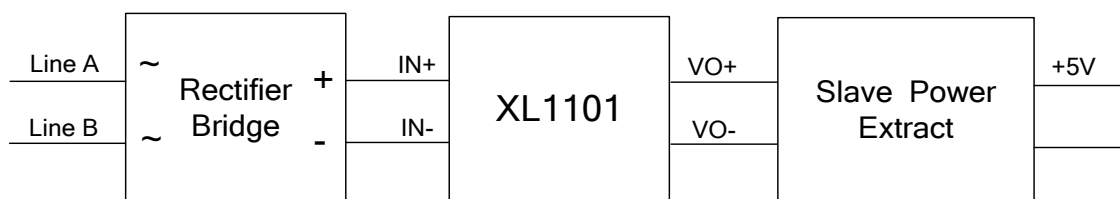


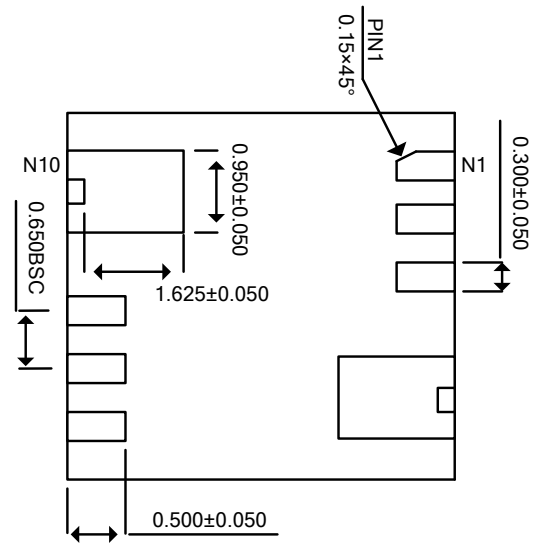
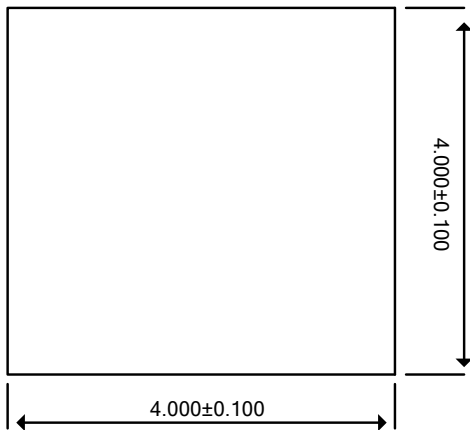
Figure5.XL1101 Application Schematic–Slave Power Extract

60V 200mA Active Inductor

XL1101

Package Information

DFN4*4-10



60V 200mA Active Inductor	XL1101
---------------------------	--------

Important Notice

XLSEMI reserve the right to make modifications, enhancements, improvements, corrections or other changes without notice at any time. XLSEMI does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others. XLSEMI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using XLSEMI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards. XLSEMI warrants performance of its products to the specifications applicable at the time of sale, in accordance with the warranty in XLSEMI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent XLSEMI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

For the latest product information, go to www.xlsemi.com.